

**SIEMENS**

# SFH6345

## High Speed 5.3 kV Optocoupler

**FEATURES**

- Direct Replacement for HCPL4503
- High Speed Optocoupler without Base Connection
- GaAlAs Emitter
- Integrated Detector with Photodiode and Transistor
- High Data Transmission Rate: 1 MBit/s
- TTL Compatible
- Open Collector Output
- CTR at  $I_F=16$  mA,  $V_O=0.4$  V,  $V_{CC}=4.5$  V,  $T_A=25^\circ\text{C}$ :  $\geq 19\%$
- Good CTR Linearity Relative to Forward Current
- Field Effect Stable
- Low Coupling Capacitance
- Very High Common Mode Transient Immunity  $dV/dt: \geq 15$  kV/ $\mu\text{s}$  at  $V_{CM}=1500$  V
- Insulation Test Voltage: 5300 VAC<sub>PK</sub>
- VDE 0884 Available with Option 1
- UL Approval, File #E52744

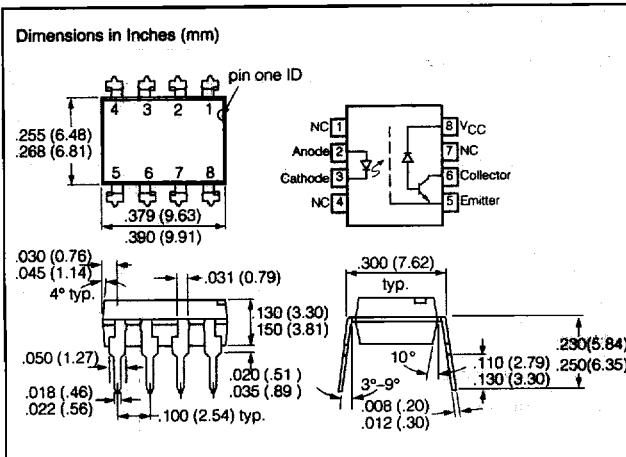
**APPLICATIONS**

- Data Communications
- IGBT Drivers
- Programmable Controllers

**DESCRIPTION**

The SFH6345 is an optocoupler with a GaAlAs infrared emitting diode, optically coupled to an integrated photodetector consisting of a photodiode and a high speed transistor in a DIP-8 plastic package. The device is similar to the 6N135 but has an additional Faraday shield on the detector which enhances the input-output  $dv/dt$  immunity.

Signals can be transmitted between two electrically separated circuits up to frequencies of 2 MHz. The potential difference between the circuits to be coupled should not exceed the maximum permissible reference voltages.

**Absolute Maximum Ratings****Emiter (GaAlAs)**

Reverse Voltage.....	3 V
DC Forward Current.....	25 mA
Surge Forward Current ( $t_p \leq 1$ $\mu\text{s}$ , 300 pulses/sec.).....	1 A
Total Power Dissipation.....	45 mW

**Detector (Si Photodiode + Transistor)**

Supply Voltage.....	-0.5 to 30 V
Output Voltage.....	-0.5 V to 25 V
Output Current.....	8 mA
Total Power Dissipation.....	100 mW

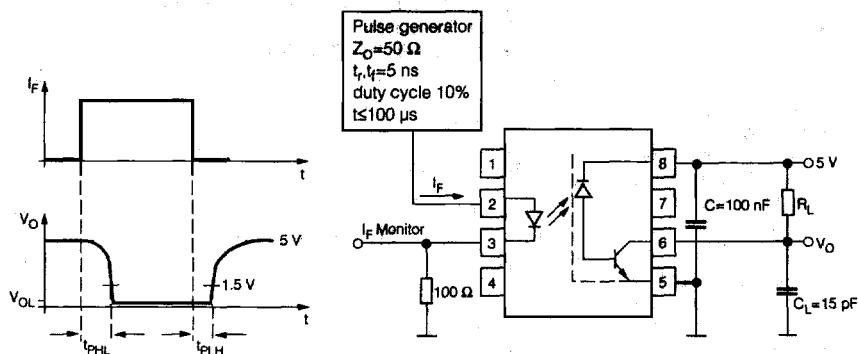
**Package Insulation**

Isolation Test Voltage between emitter and detector.....	5300 VAC <sub>PK</sub>
(refer to climate DIN 40046, part 2, Nov. 74)	
Creepage.....	$\geq 7$ mm min.
Clearance.....	$\geq 7$ mm min.
Comparative Tracking Index per DIN IEC 112/VDE0303, part 1.....	$\geq 175$
Isolation Resistance $V_{IO}=500$ V, $T_A=25^\circ\text{C}$ , $R_{ISOL}$ .....	$\geq 10^{12} \Omega$
$V_{IO}=500$ V, $T_A=100^\circ\text{C}$ , $R_{ISOL}$ .....	$\geq 10^{11} \Omega$
Storage Temperature Range.....	-55 to +150°C
Ambient Temperature Range.....	-55 to +100°C
Junction Temperature.....	100°C
Soldering Temperature ( $t=10$ sec. max.).....	260°C
Dip soldering: distance to seating plane $\geq 1.5$ mm	

**Characteristics ( $T_A=0^\circ$  to  $70^\circ\text{C}$ , unless otherwise specified, typical values  $T_A=25^\circ\text{C}$ )**

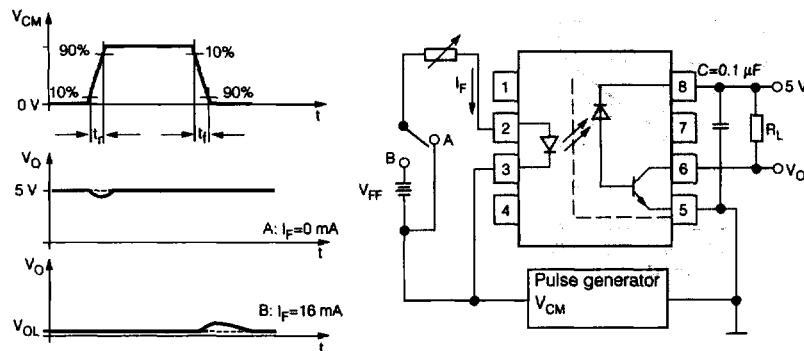
Description	Symbol	Min.	Typ.	Max.	Unit	Condition
<b>Emitter (IR GaAlAs)</b>						
Forward Voltage	$V_F$		1.6	1.9	V	$I_F=16 \text{ mA}$
Reverse Current	$I_R$		0.5	10	$\mu\text{A}$	$V_R=3 \text{ V}$
Capacitance	$C_0$		75		$\text{pF}$	$V_R=0 \text{ V}, f=1 \text{ MHz}$
Thermal Resistance	$R_{thJA}$		700		$^\circ\text{K/W}$	
<b>Detector (Si Photodiode + Transistor)</b>						
Supply Current, Logic High	$I_{CCH}$		0.01	1	$\mu\text{A}$	$I_F=0, V_O(\text{open}), V_{CC}=15 \text{ V}, T_A=25^\circ\text{C}$
				2		$I_F=0, V_O(\text{open}), V_{CC}=15 \text{ V}$
Output Current, Output High	$I_{OH}$		.003	0.5	$\mu\text{A}$	$I_F=0, V_O=V_{CC}=5.5 \text{ V}, T_A=25^\circ\text{C}$
				.01	1	$I_F=0, V_O=V_{CC}=15 \text{ V}, T_A=25^\circ\text{C}$
				—	50	$I_F=0, V_O=V_{CC}=15 \text{ V}$
Capacitance	$C_{CE}$		3		$\text{pF}$	$V_{CE}=5 \text{ V}, f=1 \text{ MHz}$
Thermal Resistance	$R_{thJA}$		300		$^\circ\text{K/W}$	
<b>Package</b>						
Coupling Capacitance	$C_C$		0.6		$\text{pF}$	
Coupling Transfer Ratio	$I_O/I_F$	19	30		%	$I_F=16 \text{ mA}, V_O=0.4 \text{ V}, V_{CC}=4.5 \text{ V}, T_A=25^\circ\text{C}$
		15	—			$I_F=16 \text{ mA}, V_O=0.5 \text{ V}, V_{CC}=4.5 \text{ V}$
Collector Emitter Saturation Voltage	$V_{OL}$		0.1	0.4	V	$I_F=16 \text{ mA}; I_O=2.4 \text{ mA}, V_{CC}=4.5 \text{ V}, T_A=25^\circ\text{C}$
Supply Current, Logic Low	$I_{CL}$		80	200	$\mu\text{A}$	$I_F=16 \text{ mA}, V_O \text{ open}, V_{CC}=15 \text{ V}$

**Figure 1. Switching times (typ.)**



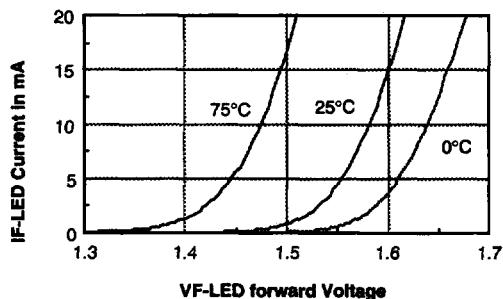
Description	Symbol	Min.	Typ.	Max.	Unit
Propagation Delay Time (High-Low) $I_F=16 \text{ mA}, V_{CC}=5 \text{ V}, R_L=1.9 \text{ k}\Omega, T_A=25^\circ\text{C}$	$t_{PHL}$		0.3	0.8	$\mu\text{s}$
Propagation Delay Time (Low-High) $I_F=16 \text{ mA}, V_{CC}=5 \text{ V}, R_L=1.9 \text{ k}\Omega, T_A=25^\circ\text{C}$	$t_{PLH}$		0.3	0.8	$\mu\text{s}$

**Figure 2. Common mode transient immunity**

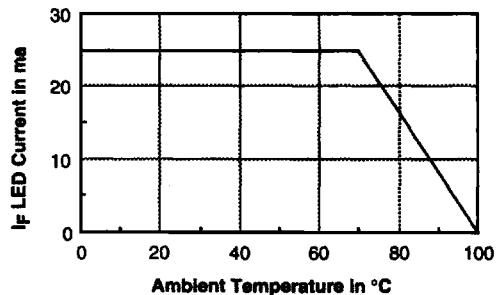


Description	Symbol	Min.	Typ.	Max.	Unit
Common Mode Transient Immunity (High) $I_F=0, V_{CM}=1500 \text{ V}_{P-P}, R_L=1.9 \text{ k}\Omega, V_{CC}=5 \text{ V}, T_A=25^\circ\text{C}$	$ ICM_H $	15	30		$\text{kV}/\mu\text{s}$
Common Mode Transient Immunity (Low) $I_F=16 \text{ mA}, V_{CM}=1500 \text{ V}_{P-P}, R_L=1.9 \text{ k}\Omega, V_{CC}=5 \text{ V}, T_A=25^\circ\text{C}$	$ ICM_L $	15	30		$\text{kV}/\mu\text{s}$

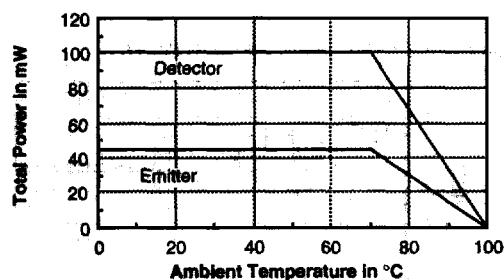
**Figure 3. LED forward current vs. forward voltage**



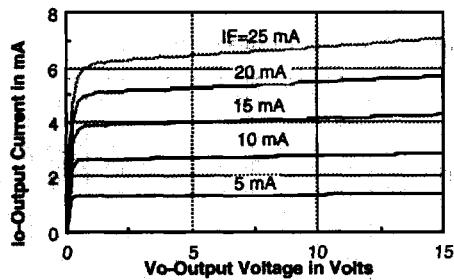
**Figure 4. Permissible forward LED current vs. temperature**



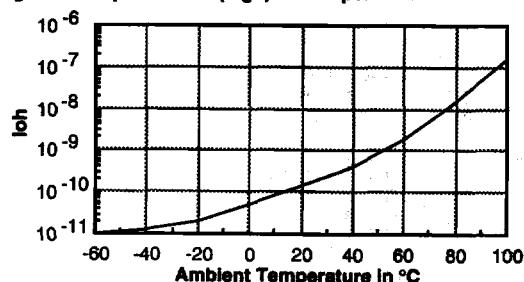
**Figure 5. Permissible power dissipation vs. temp.**



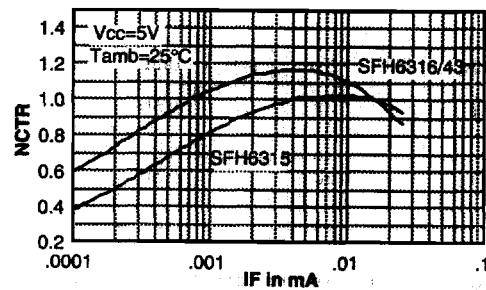
**Figure 6. Output current vs. output voltage**



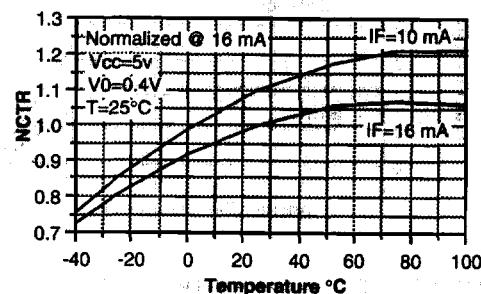
**Figure 7. Output current (high) vs. temperature**



**Figure 8. NCTR vs. IF**



**Figure 9. NCTR vs. temperature (SFH6316/43)**



**Figure 10. NCTR vs. temperature (SFH6315)**

